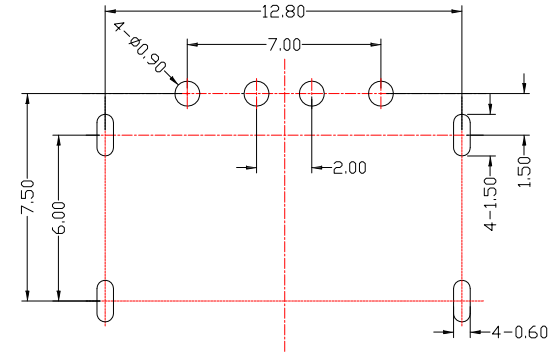
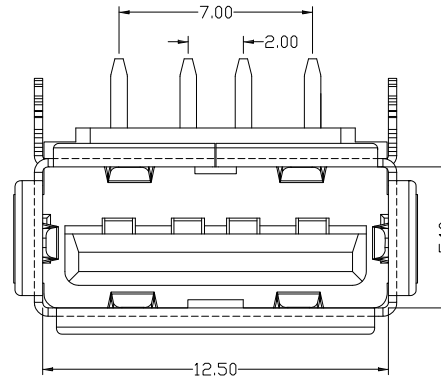
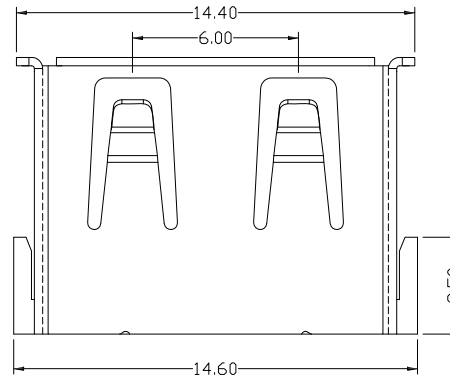
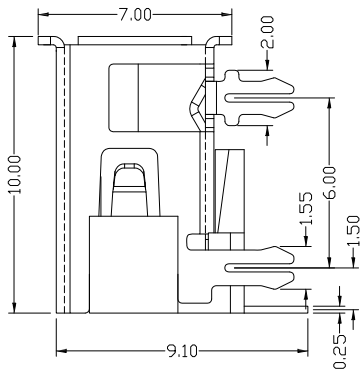
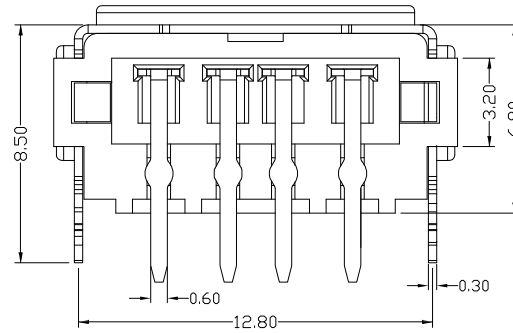


SUA-110H4-x-S235

COLOR :

Black: B

White : W



PCB LAYOUT MOUNTING PATTERN

SPECIFICATIONS

Electrical:

- 1.Dielectric Withstanding Voltage: AC 500 V / 1MIN
- 2.Insulation Resistance: 1,000 M Ω Min
- 3.Contact Resistance: 30 m Ω Max
- 4.Operating Temperature: -25°C ~ 85°C

Mechanical:

- 1.Mechanical Characteristics:
 - Insertion force: 3.57 kgf (Max)
 - Extraction force: 1.02 kgf (Min)

Material:

- 1.Housing: LCP
- 2.Contact: Phosphor Bronze
- 3.Shell: Brass

Finish:

- 1.Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer



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TOLERANCE UNLESS
OTHERWISE STATED :

Up to 5 ± 0.2
Above 5 ~ 15 ± 0.3
Above 15 ~ 30 ± 0.4
Above 30 ~ 50 ± 0.5
Angle $\pm 0.3^\circ$

3RD.
ANGEL'S



UNITS

MM

DRAWN BY:	DATE	MAT'L	TITLE	CONNECTOR
Jack Lu	10/21/13			
CHECKED BY:	DATE	FINISH	MODLE	USB AF 10.0插板四腳有卷邊 ≈ 6.8
Jacky Chen	10/21/13			
APPROVED BY:	DATE	SCALE	DWG NO.	SUA-110H4-x-S235
Tony Kao	10/21/13	1 : 1		
		SHEET NO.	PART NO.	SUA-110H4-x-S235